

- Low-loss UHF SAW Filter
- 3.0 x 3.0 Surface-mount Package
- Complies with Directive 2002/95/EC (RoHS)



SF2249E

1602 MHz SAW Filter



Maximum Rating

Rating	Value	Units
Input Power Level	+10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds/5 cycles maximum	260	°C

Characteristic	Sym	Not	Min	Тур	Max	Units	
Center Frequency	f _C			1602	MHz		
3 dB Bandwidth	BW ₃			61		- IVIHZ	
Insertion Loss, 1596 to 1607 MHz	IL			3.0	4.0	dB	
Amplitude Ripple, 1596 to 1607 MHz				0.6	2.0	dB	
Group Delay Ripple, 1596 to 1607 MHz				6	15	ns	
Input/Output Return Loss, 1596 to 1607 MHz			8	9		dB	
Attenuation, 0 dB Reference:							
10 to 1500 MHz			45	48		٩D	
1700 to 2400 MHz			43	50		dB	
200 ohm Balanced Source Impedance			200 Ω 18 nH				
200 ohm Balanced Load Impedance			200 Ω 18 nH				

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization, Y=year, WW=week, S=shift, dot=pin 1 indicator	990, YWWS	
Standard Reel Quantity Reel Size 7 inch	500 Pieces/Reel	
Reel Size 13 inch	3000 Pieces/Reel	

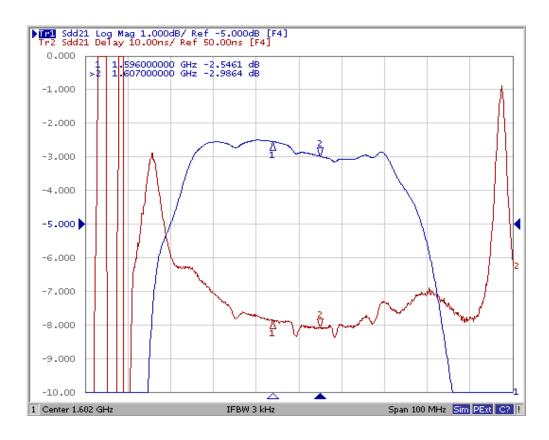
Electrical Connections

Connection	Terminals
Input	1, 2
Balanced Output	5, 6
Case Ground	All others



- 1. US and international patents may apply.
- 2. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.
- 3. Electrostatic Sensitive Device. Observe precautions for handling.

Filter Response Plots

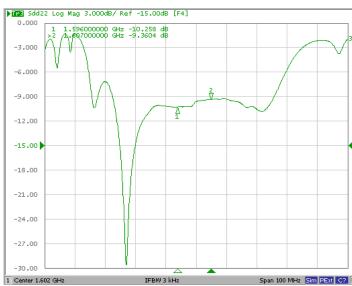




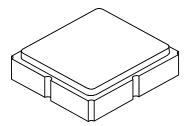


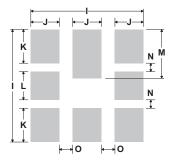
Input/Output Return Loss Plots





8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





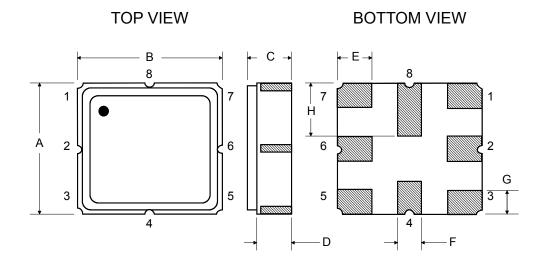
PCB Footprint Top View

Case and PCB Footprint Dimensions

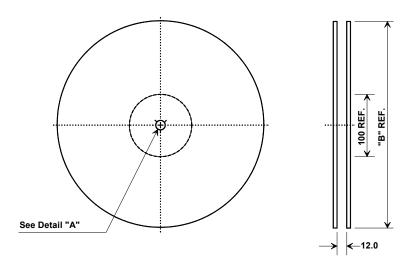
Dimension	mm			Inches		
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	-	-	1.10	-	-	0.043
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
Н	1.07	1.20	1.33	0.042	0.047	0.052
ı		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
0		0.38	_		0.015	

Case Materials

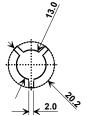
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				



Tape and Reel Specifications



"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.4 mm			
Pitch	8.0 mm			
W	12.0 mm			

COMPONENT ORIENTATION and DIMENSIONS

